

SID

Factory: Rot am See

Article:

ML4

Provided:

Customer:

Date:

31.03.2026

WÜRTH  
ELEKTRONIK  
MORE THAN  
YOU EXPECT

Processtechnology: B: undefined

| Material Text | Mat. Nr. | µm | Stackup | Process overview |
|---------------|----------|----|---------|------------------|
|---------------|----------|----|---------|------------------|

|  |          |     |    |   |         |
|--|----------|-----|----|---|---------|
| A-RS Kupferfolie-035my 330x490mm         | 50200242 | 35  | VS | 1 | A00 B00 |
| C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B... | 50203000 | 168 |    | 2 |         |
| C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B... | 50203001 | 0   |    | 3 |         |
|  |          | 70  | L2 |   |         |
| C-RaS-FR4-DS-0.991mm-070+070-TG150-HF... | 50203142 | 850 |    | 4 |         |
|  |          | 70  | L3 |   |         |
|  |          |     |    |   |         |
| C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B... | 50203001 | 168 |    | 5 |         |
| C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B... | 50203000 | 0   |    | 6 |         |
| A-RS Kupferfolie-035my 330x490mm         | 50200242 | 35  | RS | 7 |         |

Thickness after Pressing

B00: 1440 µm Tol+: 155 µm Tol-: 155 µm Dmax: 1595 µm Dmin: 1285 µm

Thickness over all

0 µm Tol+: 0 µm Tol-: 0 µm Dmax: 0 µm Dmin: 0 µm

Demand for customer

Thickness (D): 1550 µm Tol+: 155 µm Tol-: 155 µm Dmax: 1705 µm Dmin: 1395 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal: 1396 µm

Version 1.2.20.35

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